APPLICATIONS

The **EM BSIP-NUCD** is a german engineered and produced high quality fanless BoxPC System. Designed as a flexible low power system with an excellent performance-per-watt ratio it is optimal adapted for:

- _ Al Systems
- _ ML Machine Learning
- _ CV Computer Vision
- Robotics
- _ Mobile Systems
 automotive power supply
- _ Rugged Industrial Systems no rotating parts, low power
- _ Medical Solutions AMD Ryzen™ performance
- _ loT edge / fog gateway

¹10 years availability according to CPU manufacturers specification













SPECIFICATIONS

€X	CPU	AMD R2000 series ¹ , up to 3.5 GHz Up to 4 cores, 4 threads, max. 25 W supported
	Max. memory	Up to 32 GB dual channel DDR4 memory
. 8 .	Gigabit Ethernet	2 Intel® I225* with IEEE1588
	SD-Card	1 MicroSD-Card socket
	M.2 socket	1 Key B, 30 mm x 42 mm with onboard SIM Card socket 1 Key E, 22 mm x 30 mm 1 Key M, 22 mm x 42 mm (for NVMe and SATA only)
	USB port	1 Dual USB 3.1 Gen2 (10Gb/s, fused to: 900mA each) 1 Rear USB 3.1 Gen2 (10Gb/s, fused to: 900mA) 1 internal USB 3.1 Gen2 (10Gb/s, fused to: 900mA)
	Serial port	1 RS-232 1 RS-232/485 (FDX)
a	DP connector	2 Mini-DP++ connectors up to 4096 x 2160 @ 60 Hz
	Sound	HDA with MIC In / headphone Out / Line In / Line Out
0 1	Health monitoring and management	Hardware monitoring and watchdog
	fTPM	AMD firmware Trusted Platform Module TPM 2.0 support (Infinion SLB9670)
	Power supply	Min. 8 V / Max. 32 V (DC) automotive grade KL15
	Max. operating temp.	0°C to +60°C ambient commercial grade; other on request
	Max. storage temp.	-40°C to +85°C
	Max. relative humidity	95% @ 40°C, non-condensing
	Size approx.	130 x 52 x 217 mm
	Weight approx.	1.480g + options
	OS support	Microsoft® Windows® 10; Microsoft® Windows® 10 IoT Enterprise; Microsoft® Windows® 11;

Linux Ubuntu 20.04 LTS



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^{*}technische Daten gelten ab Rev. 5